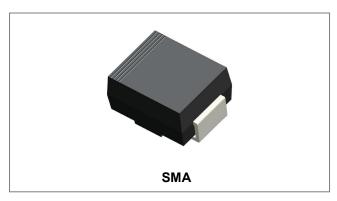


RoHS



ER3EA ULTRAFAST RECTIFIER



Features

- Glass Passivated Die Construction
- Ideally Suited for Automatic Assembly
- Low Forward Overload Drop, High Efficiency
- Low Power Loss
- Super-Fast Recovery Time
- Plastic Case Material has UL Flammability Classification Rating 94V-O
- This is a Pb Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

Circuit Diagram



Mechanical Data

- Case: Low Profile Molded Plastic
- Terminals: Solder Plated, Solderable per MIL-STD-750, Method 2026
- Polarity: Cathode Band or Cathode Notch
- Marking: Type Number
- Weight: 0.06 grams(approx)

Maximum Ratings and Electrical Characteristics @TA=25°C unless otherwise specified

Characteristic	Symbol	ER3EA	Units
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	300	V
Average Rectified Output Current @T _L = 75°C	lo	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	I _{FSM}	100	Α
Forward Voltage @I _F = 3.0A, T _J =25°C	VF	1.25	V
Peak Reverse Current @T _A = 25°C At Rated DC Blocking Voltage @T _A = 100°C	I _{RM}	5.0 500	μA
Typical Thermal Resistance Junction to Lead (Note 1)	R _{θJL}	16	K/W
Maximum Reverse Recovery Time (Note 2)	Trr	35	ns
Typical Junction Capacitance (Note 3)	Сл	45	pF
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

- Note: 1. Mounted on P.C. Board with 8.0mm² lead area
 - 2. Measured with I_F =0.5A, I_R =1.0A, I_{rr} =0.25A
 - 3. Measured at 1.0 MHZ and applied reverse voltage of 4.0 V_{DC}
 - China Germany Korea Singapore United States
 - http://www.smc-diodes.com
 sales@ smc-diodes.com







Ratings and Characteristics Curves

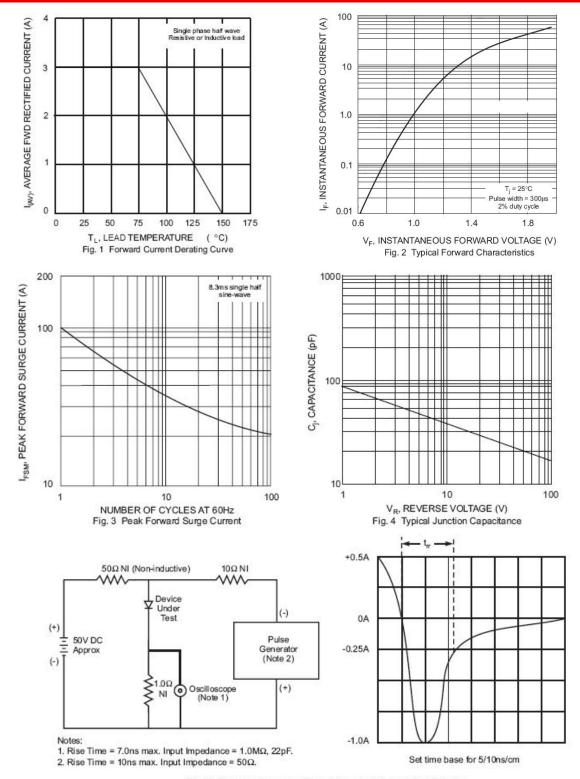


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit

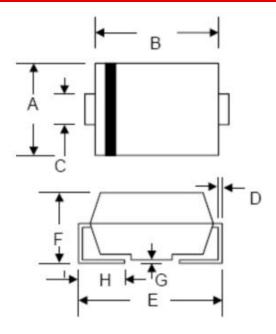
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Mechanical Dimensions SMA



CVMDOL	Millimeters		Inche	hes
SYMBOL	Min.	Max.	Min.	Max.
Α	2.40	2.84	0.094	0.112
В	3.99	4.75	0.157	0.187
С	1.05	1.70	0.041	0.067
D	0.15	0.51	0.006	0.020
E	4.80	5.66	0.189	0.223
F	1.90	2.95	0.075	0.116
G	0.05	0.203	0.002	0.008
Н	0.76	1.52	0.030	0.600

Ordering Information

Device	Package	Shipping	
ER3EA	SMA (Pb-Free)	5000pcs / reel	

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our tape and reel packaging specification.

Marking Diagram

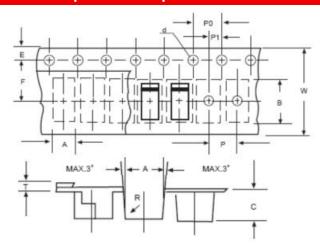
Where XXXXX is YYWWL



Cautions: Molding resin

Epoxy resin UL:94V-0

Carrier Tape & Reel Specification SMA



SYMBOL	Millimeters		
STIMBOL	Min.	Max.	
Α	2.97	3.17	
В	5.70	5.90	
С	2.32	2.52	
d	1.40	1.60	
E	1.40	1.60	
F	5.60	5.70	
Р	3.90	4.10	
P0	3.90	4.10	
P1	1.90	2.10	
Т	0.25	0.35	
W	11.80	12.20	

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